MA6X718 (MA718)

Silicon epitaxial planar type

For switching circuits

For wave detection circuit

Features

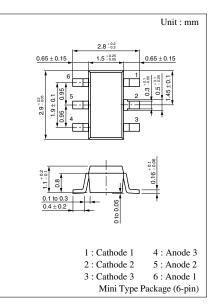
- Three MA3X704As in the same direction are contained in one package
- Optimum for low-voltage rectification because of its low forward rise voltage (V_F)
- Optimum for high-frequency rectification because of its short reverse recovery time (t_{rr})

Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter | Symbol | Rating | Unit |
|-----------------------|------------------|-------------|------|
| Reverse voltage (DC) | V _R | 30 | V |
| Peak forward current* | I_{FM} | 150 | mA |
| Forward current (DC)* | I_F | 30 | mA |
| Junction temperature | Tj | 125 | °C |
| Storage temperature | T _{stg} | -55 to +125 | °C |

Note) * : Value in per diode

Electrical Characteristics $T_a = 25^{\circ}C$



Marking Symbol: M2N

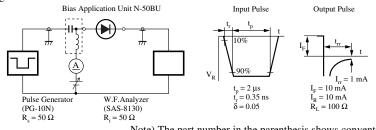
Internal Connection

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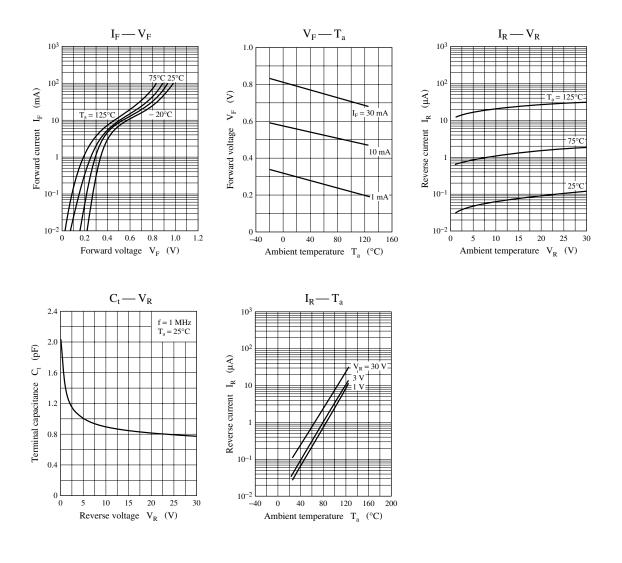
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|------------------------|-----------------|--|-----|-----|-----|------|
| Reverse current (DC) | I _R | $V_R = 30 V$ | | | 1 | μΑ |
| Forward voltage (DC) | V _{F1} | $I_F = 1 \text{ mA}$ | | | 0.4 | V |
| | V _{F2} | $I_F = 30 \text{ mA}$ | | | 1.0 | V |
| Terminal capacitance | Ct | $V_R = 1 V, f = 1 MHz$ | | 1.5 | | pF |
| Reverse recovery time* | t _{rr} | $I_F = I_R = 10 \text{ mA}$ $I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$ | | 1.0 | | ns |
| Detection efficiency | η | $V_{in} = 3 V_{(peak)}, f = 30 MHz$ $R_L = 3.9 k\Omega, C_L = 10 pF$ | | 65 | | % |

Note) 1. Schottky barrier diode is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment

- 2. Rated input/output frequency: 2 000 MHz
- 3. *: t_{rr} measuring instrument



Note) The part number in the parenthesis shows conventional part number.



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